

DRAGONFLY® S

Industrial Machine Vision Cameras | DR-U3-50Y2M and DR-U3-50Y2C



KEY FEATURES

Flexible Camera Configurations

Board-level to fully enclosed models with lightweight aluminum case. Side/back USB3 connector orientations, with locking mechanism.

Compact And Lightweight

Compact, lightweight design for handheld or embedded devices. Class B EMC safety compliant for cased models.

Reliable Image Delivery

Onboard image buffering ensures that every captured image frame is reliably transferred to the host CPU

APPLICATIONS

- Ophthalmoscopy
- Biometrics Kiosk Solutions
- Mobile Robotics
- Handheld 3D Scanning
- Automated Optical Inspection
- Vision Based Monitoring System

Test, Develop and Deploy at Speed

Dragonfly® S is a first of its kind, practical option for industries ranging from life science instrumentation to factory automation. The modular, compact, and lightweight design accelerates the inception stage of imaging application development for at-scale manufacturing, volume-based applications, and multi-camera systems. Paired with CMOS sensor options from Sony, Onsemi and Teledyne e2v, Dragonfly® S is ideal for embedded or handheld device applications and more.

SPECIFICATIONS

| | DR-U3-50Y2M/C | |
|-------------------------------------------------------------------------------------------|------------------------------------------------|--|
| RESOLUTION | 2592 x 1944 | |
| MAX FRAME RATE | 49 fps | |
| MEGAPIXELS | 5.0 MP | |
| SENSOR MODEL | AR0521 (Rolling Shutter) | |
| SENSOR SIZE | Rolling Shutter | |
| PIXEL SIZE | 2.2 µm | |
| SPECTRUM | Mono or Color | |
| LENS MOUNT | S-mount or CS-mount | |
| ADC | 10-bit / 12-bit | |
| GAIN RANGE* | 0 – 23.1 dB | |
| EXPOSURE RANGE* | 6 μs to 0.54 seconds | |
| PARTIAL IMAGE MODES | 2x2 binning, Region of Interest | |
| IMAGE PROCESSING | Gamma, lookup table | |
| IMAGE BUFFER | 112 MB | |
| NON-ISOLATED I/O | 4 bi-directional | |
| SERIAL PORT | 1 over non-isolated I/O | |
| INTERFACE | USB 3.1 Micro B, rear or side connector | |
| 29.5 mm x 29.5 mm x 15.8-18.1 mm / 23 g (Car 27 mm x 27 mm x 9.5 mm / 5 g (Board-level | | |
| TEMPERATURE | Operating: 0°C to TBD / Storage: -30°C to 60°C | |
| HUMIDITY (NO CONDENSATION) | Operating: 20% - 85% / Storage: 20% - 95% | |
| WARRANTY | 3 years | |

*Values are the same in binning and no binning modes.



MODULAR PRODUCT CONFIGURATION



ACCESSORIES

| Product Number | Description | Accessories Photos |
|----------------|------------------------------------------------------------------------------------------------|--------------------|
| ACC-01-0020 | Dragonfly S board level universal USB locking bracket | |
| ACC-01-0017 | Tripod adaptor | |
| ACC-01-1201 | RoHS Generic USB 3.1 PCI Express 2.0 x1 host adapter card, PD720202 chipset, 2-port | |
| ACC-01-1203 | RoHS Generic USB 3.1 PCI Express 2.0 x4 host adapter card, FL1100 chipset, 4-port quad-channel | |
| ACC-01-2300 | 3 meter USB3.0 CABLE, Type-A to Micro-B (locking) | |
| ACC-01-2301 | 5 meter USB3.0 CABLE, Type-A to Micro-B (locking) | |
| ACC-01-5004 | Optical CS to C Mount 5 mm Spacer | |

FOR MORE INFORMATION CONTACT:

THE AMERICAS

T: +1 866.765.0827 (toll free) T: +1 604.242.9937

E: mv-sales@teledyne.com

EUROPE, MIDDLE EAST, & AFRICA

T: +49 7141 488817-0 F: +49 7141 488817-99

E: mv-eusales@teledyne.com

CHINA BEIJING OFFICE: T: +86-10-84669678 ex. 8019

SHANGHAI OFFICE:

T: +86-21-32501002 ex. 801 E: mv-chinasales@teledyne.com E: mv-taiwansales@teledyne.com

JAPAN AND ASIA PACIFIC

T: +81-3-5422-7866

E: mv-japansales@teledyne.com

This document does not contain information whose export/transfer/disclosure is restricted by the Canadian Export Control regulation. Teledyne FLIR reserves the right to make changes at any time without notice.

© 2024 Teledyne FLIR

Revision Date: 2024 03 05